

DATA SHEET

SKY65336-11: 2.4 GHz Transmit/Receive Front-End Module with Integrated LNA

Applications

- 2.4 GHz ISM band radios
- ZiaBee® FEMs
- IEEE 802.15.4 applications

Features

- Transmit output power > +20 dBm
- Receive NF < 3 dB
- High efficiency PA
- Programmable transmit power levels
- · Configurable transmit/receive paths
- · Internal switching and control circuits
- . Internal RF match and bias circuits
- Single DC supply = 3.0 V
- Interfaces seamlessly with Ember EM250 and EM260 ZigBee transceivers
- All RF ports are internally DC blocked
- Small footprint, MCM (28-pin, 8 x 8 mm) SMT package (MSL3, 260 °C per JEDEC J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.

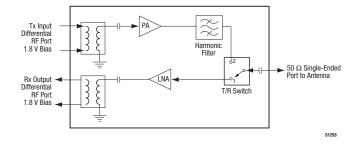


Figure 1. SKY65336-11 Block Diagram

Description

The Skyworks SKY65336-11 is a high-efficiency front-end module (FEM) for ZigBee and other 2.4 GHz ISM band applications. The small 8 x 8 mm Multi-Chip Module (MCM) contains a 2400 to 2500 MHz high-efficiency transmit path and a low-noise linear receive path.

The transmit path consists of an harmonic filter and high efficiency power amplifier (PA) capable of providing +20 dBm of power at the antenna port. Also included is an internal balun to allow use of differential input signals.

The receive path contains a high isolation transmit/receive (Tx/Rx) switch, low noise amplifier (LNA), and balun for low noise differential output.

The device is mounted in a 28-pin, 8 x 8 mm MCM surface-mount technology (SMT) package, which allows for a highly manufacturable low-cost solution.

A block diagram of the SKY65336-11 is shown in Figure 1. The device package and pinout for the 28-pin MCM are shown in Figure 2. Signal pin assignments and functional pin descriptions are described in Table 1.

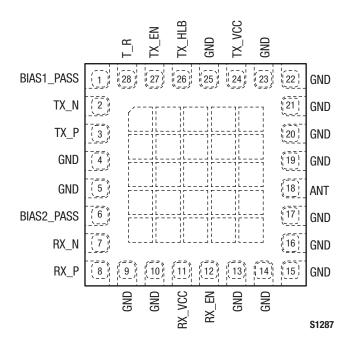


Figure 2. SKY65336-11 Pinout (Top View)

Table 1. SKY65336-11 Signal Descriptions¹

Pin	Name	Description	Pin	Name	Description
1	BIAS1_PASS	Transmit port bias supply	15	GND	Ground
2	TX_N	Negative transmit input port	16	GND	Ground
3	TX_P	Positive transmit input port	17	GND	Ground
4	GND	Ground	18	ANT	Antenna input
5	GND	Ground	19	GND	Ground
6	BIAS2_PASS	Receive port bias supply	20	GND	Ground
7	RX_N	Negative receive output port	21	GND	Ground
8	RX_P	Positive receive output port	22	GND	Ground
9	GND	Ground	23	GND	Ground
10	GND	Ground	24	TX_VCC	Transmit DC supply, +3 V
11	RX_VCC	Receive DC supply, +3 V	25	GND	Ground
12	RX_EN	Receive enable	26	TX_HLB	Transmit power mode
13	GND	Ground	27	TX_EN	Transmit enable
14	GND	Ground	28	T_R	Transmit/receive switch

The bottom ground pad <u>must be</u> connected to RF ground.

Technical Description

Transmit/Receive (Tx/Rx) Enable

Pin 27 (TX_EN) and pin 12 (RX_EN) are used to enable the transmit and receive port, respectively.

Tx/Rx Switch

Pin 28 (T R) is used to control the Tx/Rx switch.

Tx/Rx Enable and Tx/Rx Switch Mode Control

The following control logic is used to configure the transmit or receive mode of the SKY65336-11:

TX_EN	RX_EN	T_R	Mode
High	Low	High	Transmit mode
Low	High	Low	Receive mode

High-Power and Low-Power Modes

High-power mode output is 20 dBm and low-power mode output is +10 dBm. Pin 26 (TX_HLB) sets the transmit path in high-power or low-power mode according to the following logic:

TX_HLB	State
Low	High-power mode
High	Low-power mode

Bottom Center Paddles

The bottom center paddles must be electrically grounded for proper RF performance. Customers should place adequate thermal vias under the ground paddles for optimum thermal performance. The Evaluation Board layout (see Figures 3 and 4) can be used as a guide for RF ground and thermal layout.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY65336-11 are provided in Table 2. Recommended operating conditions are noted in Table 3 and electrical specifications are provided in Table 4.

Typical performance characteristics of the SKY65336-11 are shown in Figures 3 through 12.

Table 2. SKY65336-11 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	RX_VCC, TX_VCC	2.1	4	V
Control voltage BIAS1_PASS, BIAS2_PASS, TX_EN, RX_EN, TX_HLB, T_R			3.6	V
Bypass voltage	BIAS1_PASS, BIAS2_PASS		1.9	V
RF input power, antenna port	PIN_ANT		10	dBm
RF input power, transmit port	P _{IN_TX}		+8	dBm
Case operating temperature	Tc	-40	+85	°C
Storage temperature	Тѕт	-55	+125	°C
Junction temperature	TJ		+150	°C

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 3. SKY65336-11 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
Supply voltage (TX_VCC, RX_VCC)	VCC	2.7	3.0	3.6	V
Tx/Rx bias supply voltage BIAS1_PASS, BIAS2_PASS		1.7	1.8	1.9	V
Tx/Rx enable voltage: Low High	TX_ENL, RX_ENL TX_ENH, RX_ENH	1.62	0 1.80	0.1 VCC - 0.2	V V
Tx/Rx control voltage: Low High	T_RL, TX_HLBL T_RH, TX_HLBH	1.62	0 1.80	0.1 VCC - 0.2	V V
Frequency range	f	2400		2500	MHz

Table 4. SKY65336-11 Electrical Specifications¹ (VCC = 3.0 V, Tc = $25 ^{\circ}\text{C}$, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Frequency range	f		2400		2500	MHz
Return loss	RL	All RF ports	6	10		dB
Transmitter Section						
Input power range	Pin	CW, high-power or low-power mode		+3	+5	dBm
Transmit acturated output namer	Рѕат_н	High-power mode	+19.5	+20		dBm
Transmit saturated output power	Psat_l	Low-power mode	+8	+10		dBm
Operating current	Іор_н	Pout = +20 dBm in high-power mode		145	160	mA
operating current	lop_L	Pout = +10 dBm in low-power mode		70	80	mA
Harmonic levels ²	PN	CW, Pout = $+20$ dBm in high-power mode, Pout = $+10$ dBm in low-power mode		-44	-39	dBm
Saturated gain	G н	CW, high-power mode		17		dB
Saturateu yani	GL	CW, low-power mode		7		dB
Leakage current	ÎLEAK	No RF input, VCC = 3.0 V, RX_EN = 0 V, TX_EN = 0 V		0.5	2.0	μА
Receiver Section (Frequency = 2445	MHz)					
Small signal gain	G	CW	9.5	10.5		dB
Noise figure	NF			2.0	3.0	dB
Input 1 dB compression	IP1dB	CW		-11		dBm
Input IP3	IIP3	Two CW tones spaced 1 MHz apart @ PiN = -9 dBm	-1	+3		dBm
Operating current	Icc	CW		8	15	mA
Leakage current	ILEAK	No RF input, VCC = 3.0 V, RX_EN = 0 V, TX_EN = 0 V		0.5	2.0	μА

¹ Performance is guaranteed only under the conditions listed in this table.

 $^{^{\}rm 2}$ Harmonic levels using the Zigbee modulated signal are +6 dBm lower than the values shown here.

Typical Performance Characteristics (VCC = 3.0 V, Tc = 25 °C, Unless Otherwise Noted)

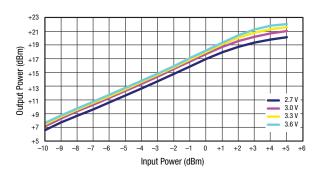


Figure 3. Output Power vs Input Power Over Voltage @ 2450 MHz

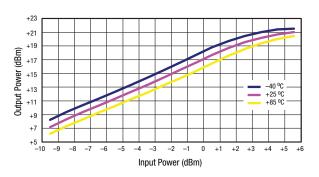


Figure 4. Output Power vs Input Power Over Temperature

@ 2450 MHz

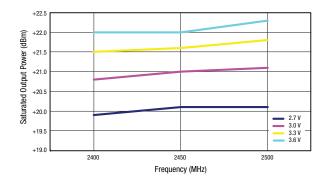


Figure 5. Saturated Output Power vs Frequency Over Voltage

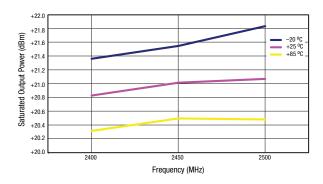


Figure 6. Saturated Output Power vs Frequency Over Temperature

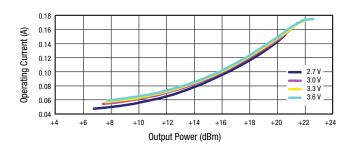


Figure 7. Operating Current vs Output Power Over Voltage

@ 2450 MHz

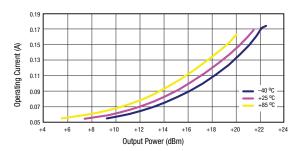


Figure 8. Operating Current vs Output Power Over Temperature
@ 2450 MHz

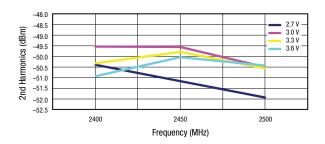


Figure 9. Second Harmonics vs Frequency Over Voltage (High-power mode)

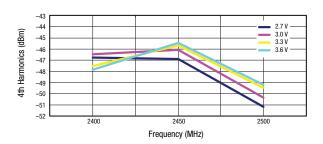


Figure 11. Fourth Harmonics vs Frequency Over Voltage (High-power mode)

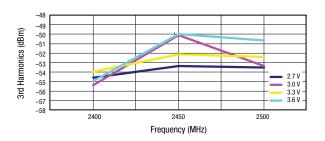


Figure 10. Third Harmonics vs Frequency Over Voltage (High-power mode)

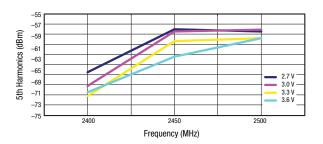


Figure 12. Fifth Harmonics vs Frequency Over Voltage (High-power mode)

Evaluation Board Description

The SKY65336-11 Evaluation Board is used to test the performance of the SKY65336-11 FEM. The Evaluation Board schematic diagram is shown in Figure 13.

An assembly drawing for the Evaluation Board is shown in Figure 14.

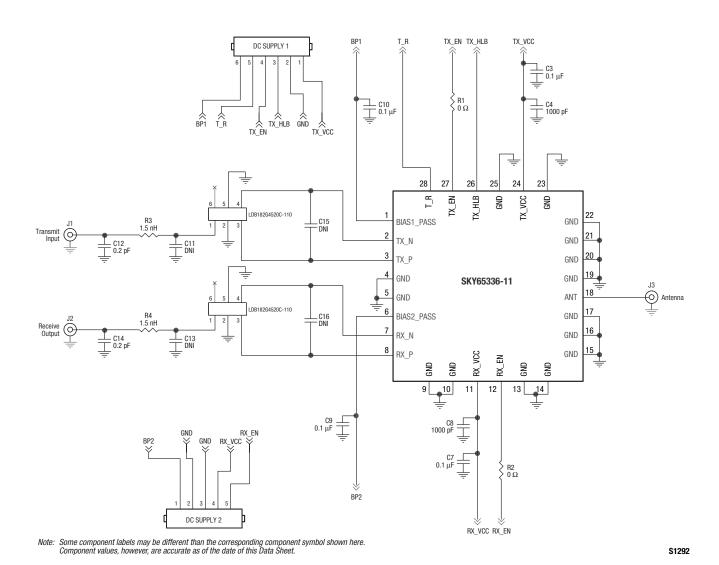


Figure 13. SKY65336-11 Evaluation Board Schematic

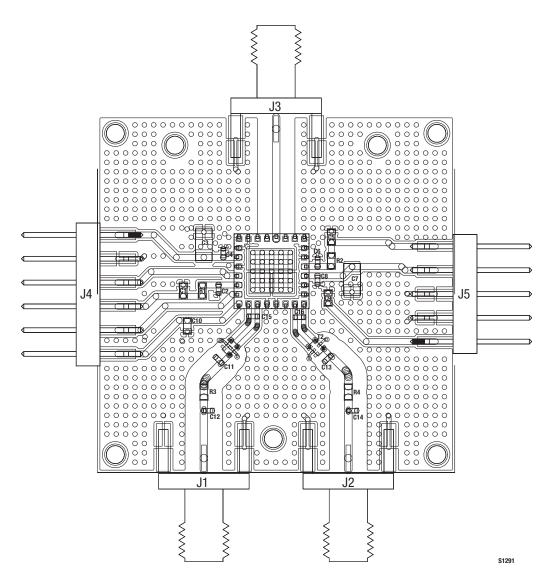


Figure 14. SKY65336-11 Evaluation Board Assembly Drawing

Package Dimensions

The PCB layout footprint for the SKY65336-11 is shown in Figure 15. Package dimensions are shown in Figure 16, and tape and reel dimensions are provided in Figure 17.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65336-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to Skyworks Application Note, *PCB Design and SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

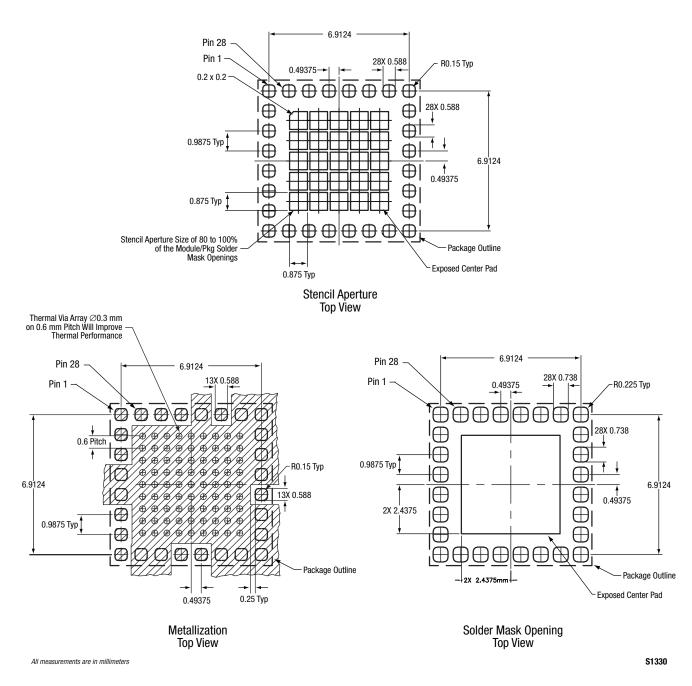


Figure 15. SKY65336-11 PCB Layout Footprint

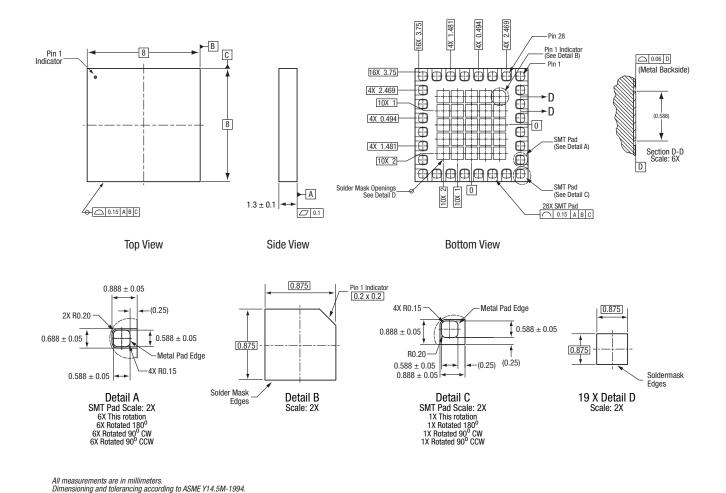
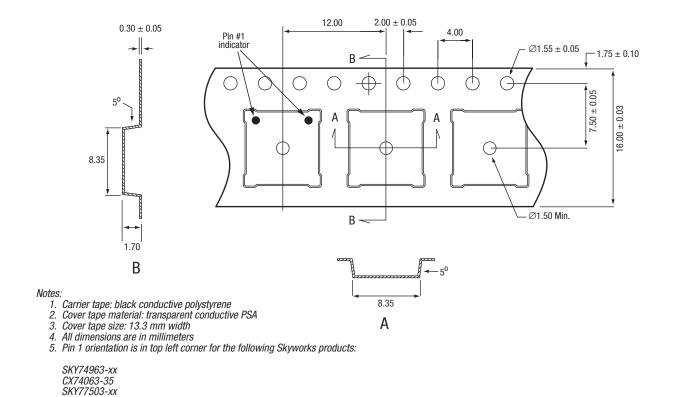


Figure 16. SKY65336-11 Package Dimensions

Pads are metal defined.

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For all other 8 x 8 mm MCM/RFLGA products, pin 1 orientation is in top right corner.

SKY77506-xx SKY77512-xx SKY77526-xx SKY77343-xx

S1290

Figure 17. SKY65336-11 Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number	
SKY65336-11 Tx/Rx FEM w/LNA	SKY65336-11	SKY65336-11-EVB	

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